

1. Record Nr.	UNISA996559972603316
Titolo	63055-2023 - IEEE/IEC International Standard--Format for LSI-Package-Board Interoperable design // IEEE
Pubbl/distr/stampa	New York, USA : , : IEEE, , 2023
ISBN	979-88-557-0216-3
Descrizione fisica	1 online resource (298 pages)
Disciplina	621.3
Soggetti	Printed circuits - Design and construction
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Sommario/riassunto	A method is provided for specifying a common interoperable format for electronic systems design. The format provides a common way to specify information-data about the project management, netlists, components, design rules, and geometries used in the large-scale integration-package-board designs. The method provides the ability to make electronic systems a key consideration early in the design process; design tools can use it to seamlessly exchange information-data.